#### DIPLOMA WING



## RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL

SCHEME OF STUDIES & EXAMINATIONS (IMPLEMENTED FROM SESSION : JULY 2023)



NAME OF BRANCH

BRANCH CODE

SEMESTER THIRD (III)

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						TE	RM	WOR	ĸĸ	THEO	RY PAPER	К			PRA EXA	ACTICAL M/VIVA	ITS	KS		
S.N.	PAPER CODE	SUBJECT CODE	SUBJECT NAME	HRS PER WEI		HRS PER WE	CREDITS	Z/ASSIGNMENT	M TEI TES	ID RM ST*	TOTAL	MARKS	DURATION	HRS PER WEE	CREDITS	LAB WORK	MARKS	DURATION	TOTAL CRED	TOTAL MAR
						gui	I	II												
1	7456	301	ELECTRONIC DEVICES & CKTS.	3	3	10	10	10	30	70	03 Hrs.	4	2	20	30	03 Hrs.	5	150		
2	7457	302	DIGITAL SYSTEM	3	3	10	10	10	30	70	03 Hrs.	4	2	20	30	03 Hrs.	5	150		
3	7458	303	ET.MEASUREMENTS & INSTRUMENTATION	З	3	10	10	10	30	70	03 Hrs.	2	1	20	30	03 Hrs.	4	150		
4	7459	304	ELECTRIC CIRCUITS & NETWORK	4	4	10	10	10	30	70	03 Hrs.	0	0	0	0	0	4	100		
5	7561	305	INTRO. TO VLSI FEBRICATION	3	3	10	10	10	30	70	03 Hrs.	0	0	0	0	0	3	100		
6			SEMICONDUCTOR LAB FAMILIARIZATION.	0	0	0	0	0	0	0	0	4	2	20	30	03 Hrs.	2	50		
7			**SUMMER INTERNSHIP- I	0	0	0	0	0	0	0	0	0	2	20	30	03 Hrs.	2	50		
8			PROFESSIONAL DEVELOPMENT	0	0	0	0	0	0	0	0	2	0	0	0	0	0	0		
9			***RECOVERY CLASSES/LIBERARY etc.	0	0	0	0	0	0	0	0	4	0	0	0	0	0	0		
			TOTAL	16	16				150	350		20	9	100	150		25	750		

**NOTE -** (1)\* Two Best, out of Three Mid Term Tests (Progressive Tests) Marks should be entered here.

(2)\*\* 3-4 Weeks Summer Internship after II Semester.

(3)\*\*\*To recover courses if session delays due to summer internship.

GRAND TOTAL OF CREDITS 25

GRAND TOTAL OF MARKS
750



DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105)

## SEMESTER III

COURSE TITLE	:	ELECTRONIC DIVICES AND CIRCUITS
PAPER CODE	:	7456
SUBJECT CODE	:	301
TREORY CREDITS	:	03
PRACTICAL CREDITS	:	02

### **Course Content:**

**Unit 1** – Semiconductor and Diodes

Definition, Extrinsic/Intrinsic, N-type & p-type PN Junction Diode – Forward and Reverse Bias Characteristics Zener Diode – Principle, characteristics, construction, working Diode Rectifiers – Half Wave and Full Wave Filters – C, LC and PI Filters

Unit 2 - Bipolar Junction Transistor (BJT)

NPN and PNP Transistor – Operation and characteristics Common Base Configuration – characteristics and working Common Emitter Configuration – characteristics and working Common Base Configuration – characteristics and working High frequency model of BJT Classification of amplifiers, negative feedback

## Unit 3 – Field Effect Transistors

FET – Working Principle, Classification
MOSFET Small Signal model
N-Channel/ P-Channel MOSFETs – characteristics, enhancement and depletion mode, MOS-FET as a Switch
Common Source Amplifiers
Uni-Junction Transistor – equivalent circuit and operation

### **Unit 4** – SCR DIAC & TRIAC

SCR – Construction, operation, working, characteristics DIAC - Construction, operation, working, characteristics TRIAC - Construction, operation, working, characteristics SCR and MOSFET as a Switch, DIAC as bidirectional switchComparison of SCR, DIAC, TRIAC, MOSFET

### **Unit 5** – Amplifiers and Oscillators

Feedback Amplifiers – Properties of negative Feedback, impact of feedback on different parameters

Basic Feedback Amplifier Topologies: Voltage Series, Voltage Shunt Current Series, Current Shunt

Oscillator – Basic Principles, Crystal Oscillator, Non-linear/ Pulse Oscillator

## SUGGESTED LEARNING RESOURCES:

S. No.	Title of Book	Author	Publication
1.	Analog Circuits	A.K. Maini	Khanna Publishing House Ed. 2018 (ISBN: 978-93-86173-584)
2.	Electronic Devices and Circuits	S. Salivahanan and N. Suresh Kumar	McGraw Hill Education; Fourth edition (1 July 2017) ISBN: 978-9339219505
3.	Electronics Devices and circuit theory	Boyestad & Nash- elsky	Pearson Education India; 11 edition (2015) ISBN: 978-9332542600
4.	Electronic Principles	Albert Malvino & David Bates	Tata McGraw Hill Publication 2010 ISBN: 978-0070634244
5.	Electronics Devices & Circuits	Jacob Millman	McGraw Hill Education; 4 edition (2015) ISBN: 978-9339219543

### SUGGESTED SOFTWARE/LEARNING WEBSITES:

- a. https://www.electronics-tutorials.ws/
- b. https://www.youtube.com/watch?v=Rx43l-QpeWQ
- c. https://electronicsforu.com/resources/electronic-devices-and-circuit-theory

# **ELCTRONIC DEVICES AND CIRCUITS LAB**

## **Course Content:**

## SUGGESTED PRACTICALS/ EXERCISES

The practical in this section are PrOs (i.e. sub-components of the COs) to be developed and assessed in the student for the attainment of the competency.

S. No.	Practical Outcomes (PrOs)	Unit No.
1.	Construct the circuit and plot the VI characteristics of the PN Junction Diode , find the cut in voltage	1
2.	Construct the circuit and plot the characteristics of a Zener Diode. Find the breakdown voltage	1
3.	Construct a Half Wave Rectifier and obtain regulation characteristics – Without Filters and with Filters Compare the results	1
4.	Construct a Full Wave Rectifier and obtain regulation characteristics – Without Filters and with Filters Compare the results	1
5.	Construct a Bridge Rectifier and obtain regulation characteristics – Without Filters and with Filters	1
6.	Obtain the characteristics of DIAC and TRIAC	3
7.	Simulate half wave, full wave and bridge rectifier using simulation tool like PSpice/Orcad/Multisim.	3
8.	Develop a simulation model for Voltage Series and Voltage Shunt Feedback Amplifiers	5
9.	Develop circuits for Voltage Series and Voltage Shunt Feedback Amplifiers and obtain output plots. Compare the results with the simulation model.	5
10.	Develop a simulation model for Current Series and Current Shunt Feedback Amplifiers	5
11.	Develop circuits for Current Series and Current Shunt Feedback Amplifiers and obtain output plots. Compare the results with the simulation model.	
12.	Total	

## **Reference Books:**

S. No.	Title of Book	Author	Publication
1.	Analog Circuits	A.K. Maini	Khanna Publishing House Ed. 2018 (ISBN: 978-93-86173-584)
2.	Electronic Devices and Cir- cuits	S. Salivahanan and N. Suresh Kumar	McGraw Hill Education; Fourth edi- tion (1 July 2017) ISBN: 978-9339219505
3.	Electronics Devices and circuit theory	Boyestad & Nash- elsky	PearsonEducationIn-dia;11edition(2015)ISBN: 978-9332542600
4.	Electronic Principles	Albert Malvino & Da- vid Bates	Tata McGraw Hill Publication 2010 ISBN: 978-0070634244
5.	Electronics Devices & Cir- cuits	Jacob Millman	McGraw Hill Education; 4 edition (2015) ISBN: 978-9339219543



### DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105)

## SEMESTER III

COURSE TITLE	:	DIGITAL SYSTEM
PAPER CODE	:	7457
SUBJECT CODE	:	302
TREORY CREDITS	:	03
PRACTICAL CREDITS	:	02

## **Course Content**:

Unit 1 - Number Systems & Boolean Algebra

Introduction to different number systems – Binary, Octal, Decimal, Hexadecimal

Conversion from one number system to another.

Boolean variables – Rules and laws of Boolean

AlgebraDe-Morgan's Theorem

Karnaugh Maps and their use for simplification of Boolean expressions

## Unit 2 – Logic Gates

Logic Gates – AND, OR, NOT, NAND, NOR , XOR, XNOR: Symbolic representation and truth table

Implementation of Boolean expressions and Logic Functions using gates Simplification of expressions

### Unit 3 – Combinational Logic Circuits

Arithmetic Circuits – Addition, Subtraction, 1's 2's Complement, Half Adder, Full Adder, Half Subtractor, Full Subtractor, Parallel and Series Adders

Encoder, Decoder

Multiplexer - 2 to 1 MUX, 4 to 1 MUX, 8 to 1 MUX. Applications

Demultiplexer – 1 to 2 DEMUX, 1- 4 DEMUX, 1- 8 DEMUX

Unit 4 – Sequential Logic Circuits

Flip Flops – SR,JK, T, D, FF, JK-MS, Triggering

Counters – 4 bit Up – Down Counters, Asynchronous/ Ripple Counter, Decade Counter-Mod3, Mod 7 Counter, Johnson Counter, Ring Counter

Registers – 4bit Shift Register: Serial In Serial Out, Serial in Parallel Out, Parallel In Serial Out, Parallel In Parallel Out

## **Unit 5** – Memory Devices

Classification of Memories – RAM Organization, Address Lines and Memory Sixe,

Static RAM, Bipolar RAM, cell Dynamic RAM, D RAM, DDR RAM

Read Only memory – ROM organization, Expanding memory, PROM, EPROM, EEPROM, Flash memory

Data Converters – Digital to Analog converters, Analog to Digital Converters

## **SUGGESTED LEARNING RESOURCES:**

S.No.	Title of Book	Author	Publication
1.	Digital principles & Ap- plications	Albert Paul Malvino & Donald P. Leach	McGraw Hill Education; Eighth edition ISBN: 978-9339203405
2.	Digital Electronics	Roger L. Tokheim Macmillian	McGraw-Hill Education (ISE Editions); International 2 Revised ed edition ISBN: 978-0071167963
3.	Digital Electronics – an introduction to theory and practice	William H. Goth- mann	Prentice Hall India Learning Private Limited; 2 edition ISBN: 978-8120303485
4.	Fundamentals of Logic Design	Charles H. Roth Jr.	Jaico Publishing House; First edition ISBN: 978-8172247744
5.	Digital Electronics	R. Anand	Khanna Publications, New Delhi (Edition 2018) ISBN: 978-93-82609445

# DIGITAL SYSTEM LAB

## **Course Content:**

# SUGGESTED PRACTICALS/ EXERCISES

The practical in this section are PrOs (i.e. sub-components of the COs) to be developed and assessed in the student for the attainment of the competency.

S. No.	Practical Outcomes (PrOs)	Unit No.	Approx. Hrs. Required
1.	To verify the truth tables for all logic fates – NOT OR AND NAND NOR XOR XNOR using CMOS Logic gates and TTL Logic Gates	1	02
2.	Implement and realize Boolean Expressions with Logic Gates	2	02
3.	Implement Half Adder, Full Adder, Half Subtractor, Full subtractor us- ing ICs	3	02
4.	Implement parallel and serial full-adder using ICs	3	02
5.	Design and development of Multiplexer and De-multiplexer using mul- tiplexer ICs	3	02
6.	Verification of the function of SR,D, JK and T Flip Flops	4	02
7.	Design controlled shift registers	4	02
8.	Construct a Single digit Decade Counter (0-9) with 7 segment display	4	03
9.	To design a programmable Up-Down Counter with a 7 segment display.	4	03
10.	Study of different memory ICs	5	02

S. No.	Practical Outcomes (PrOs)	Unit No.	Approx. Hrs. Required
11.	Study Digital- to – Analog and Analog to Digital Converters	5	02
12.	Simulate in Software (such as PSpice) an Analog to Digital Converter	5	03
13.	Simulate in Software (such as PSpice) an Analog to Digital Converter	5	03
	Total		30

**Reference Books:** 

S.No.	Title of Book	Author	Publication
1.	Digital principles & Ap- plications	Albert Paul Malvino & Donald P. Leach	McGraw Hill Education; Eighth edition ISBN: 978-9339203405
2.	Digital Electronics	Roger L. Tokheim Macmillian	McGraw-Hill Education (ISE Editions); International 2 Revised ed edition ISBN: 978-0071167963
3.	Digital Electronics – an introduction to theory and practice	William H. Goth- mann	Prentice Hall India Learning Private Limited; 2 edition ISBN: 978-8120303485
4.	Fundamentals of Logic Design	Charles H. Roth Jr.	Jaico Publishing House; First edition ISBN: 978-8172247744
5.	Digital Electronics	R. Anand	Khanna Publications, New Delhi (Edition 2018) ISBN: 978-93-82609445



### DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105)

## SEMESTER III

COURSE TITLE	:	ELECTRONIC MEASUREMENT AND INSTRIMENTATION
PAPER CODE	:	7458
SUBJECT CODE	:	303
TREORY CREDITS	:	03
PRACTICAL CREDITS	:	01

### **Course Content**:

## Unit - I Basics of Measurements and Bridges

Accuracy & precision, Resolution Types of Errors DC Bridges – Wheatstone and Kelvin Double Bridge AC Bridges - Maxwell's Bridge, Hay's Bridge, Anderson Bridge, De-Sauty's Bridge

### **Unit- II Potentiometer**

Basic DC slide wire PotentiometerCrompton's DC Potentiometer Applications of DC Potentiometer AC Potentiometers Applications of AC Potentiometers

## **Unit- III Measuring Instruments**

Permanent Magnet Moving Coil Instruments (PMMC)Moving Iron type Instruments (MI) Electro Dynamo Type Instruments Single Phase Energy Meter

## **Unit- IV Electronic Instruments**

Electronic Voltmeter and Digital VoltmeterElectronic Multimeters Q – Meter Vector Impedance Meter

### **Unit-VOscilloscopes**

Cathode ray tube: construction, operation, screens, graticules Vertical deflection system, Horizontal deflection system, Delay line, Measurement of frequency, time delay, phase angle and modulation index (trapezoidal meth-od) Oscilloscope probe: Structure of 1:1 and 10:1 probeMultiple Trace CRO

## **Unit-VI Transducers**

Classification, Selection Criteria, Characteristics, Construction, Working Principles and Ap-plication of following Transducers: RTD, Thermocouple, ThermistorLVDT, Strain Gauge Load Cell Piezoelectric Transducers

## SUGGESTED LEARNING RESOURCES:

S. No.	Title of Book	Author	Publication
1.	Electrical & Electronic Measurement & Instruments	A.K. Sawhney	Dhanpat Rai & Sons, India
2.	Electronic Instrument and Measure- ment Technique	W.D. Cooper	Prentice Hall Internation- al, India.
3.	Electronic Measurement & Instru- mentation	J.G. Joshi	Khanna Publishing House, Delhi
4.	Measurement systems application and design	E.O. Doebelin and D. N. Manik	The Mcgraw-Hill
5.	Electronic Measurements and Instru- mentation	Oliver and Cage	The Mcgraw-Hill
6.	Basic Electrical Measurement	M.B. Stout	Prentice hall of India, In- dia
7.	Electronic Instrumentation	H. S. Kalsi	The Mcgraw-Hill
8.	Electrical and Electronics Measure- ment and Instrumentation	Prithwiraj Pukrait, Bud- haditya Biswas, Santanu Das, Chiranjib Koley	The Mcgraw-Hill

# **ELECTRONIC MEASUREMENTS AND INSTRIMENTATION LAB**

## **Course Content:**

## SUGGESTED PRACTICALS/ EXERCISES

The practical in this section are PrOs (i.e. sub-components of the COs) to be developed and assessed in the student for the attainment of the competency.

S. No.	Practical Outcomes (PrOs)	Unit No.	Approx Hrs. Required
1.	Measure unknown inductance using following bridges (a) Ander- son Bridge (b) Maxwell Bridge	Ι	4
2.	Measure Low resistance by Kelvin's Double Bridge	Ι	2
3.	Calibrate an ammeter using DC slide wire potentiometer	II	2
4.	Calibrate a voltmeter using Crompton potentiometer	II	2
5.	Measure low resistance by Crompton potentiometer	II	2
6.	Calibrate a single-phase energy meter by phantom loading	III	2
7.	Study the working of Q-meter and measure Q of coils	IV	2

8.	Study working and applications of (i) C.R.O. (ii) Digital Storage C.R.O. & (ii) C.R.O. Probes	V	2
9.	Measurement of displacement with the help of LVDT	VI	2
10.	Draw the characteristics of the following temperature transducers (a) RTD (Pt-100) (b) Thermistor	VI	2
11.	Measurement of strain/force with the help of strain gauge load cell	VI	2

## **Reference Books:**

S. No.	Title of Book	Author	Publication
1.	Electrical & Electronic Measure- ment & Instruments	A.K. Sawhney	Dhanpat Rai & Sons, India
2.	Electronic Instrument and Mea- surement Technique	W.D. Cooper	Prentice Hall Internation- al, India.
3.	Electronic Measurement & Instru- mentation	J.G. Joshi	Khanna Publishing House, Delhi
4.	Measurement systems application and design	E.O. Doebelin and D. N. Manik	The Mcgraw-Hill
5.	Electronic Measurements and In- strumentation	Oliver and Cage	The Mcgraw-Hill
6.	Basic Electrical Measurement	M.B. Stout	Prentice hall of India, In- dia
7.	Electronic Instrumentation	H. S. Kalsi	The Mcgraw-Hill
8.	Electrical and Electronics Measure- ment and Instrumentation	Prithwiraj Pukrait, Bud- haditya Biswas, Santanu Das, Chiranjib Koley	The Mcgraw-Hill



### DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105) SEMESTER III

COURSE TITLE	:	ELECTRIC CIRCUITS & NETWORK
PAPER CODE	:	7459
SUBJECT CODE	:	304
TREORY CREDITS	:	04
PRACTICAL CREDITS	:	00

### **Course Content**:

### Unit - 1 Basics of Network and Network Theorem

- Node and Mesh
- Analysis
- Superposition
- Theorem Thevenin
- Theorem Norton
- Theorem

Maximum Power transfer theorem

**Reciprocity Theorem** 

## Unit- 2 Graph Theory

Graph of network, tree, incidence matrix

F- Tie Set AnalysisF-Cut Set Analysis Analysis of resistive network using cut-set and tie-set Duality

## **Unit-3 Time Domain and Frequency Domain Analysis**

Solution of first and second order differential equations for Series and parallel R-L, R-C, R-L-C circuits

Initial and Final conditions in network

- elementsForced and Free response, time
- constants Steady State and Transient State
- Response

Analysis of electrical circuits using Laplace Transform for standard inputs (unit, Ramp, Step)

### Unit-4 Trigonometric and exponential Fourier series

Discrete spectra and symmetry of waveform

Steady state response of a network to non-sinusoidal periodic inputs, power factor, effective values

Fourier transform and continuous spectra

## **Unit-5 Two Port Network**

Two Port Network Open Circuit Impedance Parameters Short Circuit Admittance Parameters Transmission Parameters Hybrid Parameters Interrelationship of Two Port NetworkInter Connection of Two Port Network

## SUGGESTED LEARNING RESOURCES:

SUGGESTED SOFTWARE/LEARNING

WEBSITES

S. No.	Title of Book	Author	Publication
1	Networks and Systems	Ashfaq Husain	Khanna Publishing House
2	Network Analysis	M. E. Van Valkenburg	Prentice Hall of India
3	Engineering Circuit Analysis	W. H. Hayt, J. E. Kemmerly and S. M. Durbin	McGraw Hill
4	Electrical Circuits	Joseph Edminister	Schaum's Outline, Tata McGraw Hill
5	Basic Circuit Theory	Lawrence P. Huelsma	Prentice Hall of India
6	Network & Systems	D. Roy Choudhury	Wiley Eastern Ltd
7	Linear Circuit Analysis	De Carlo and Lin	Oxford Press



## DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105) SEMESTER III

COURSE TITLE	:	INTRODUCTION TO VLSI FABRICATION
PAPER CODE	:	7561
SUBJECT CODE	:	305
TREORY CREDITS	:	03
PRACTICAL CREDITS	:	00

## **Course Content:**

**Unit 1**– Introduction: History of IC's; Operation & Models for Devices of Interest: CMOS and MEMS. Electronic Materials: Crystal Structures, Defects in Crystals, Si, Poly Si, Si Crystal Growth. Clean room and Wafer Cleaning: Definition, Need of Clean Room, RCA cleaning of Si.

**Unit 2**– Oxidation: Dry and Wet Oxidation, Kinetics of Oxidation, Oxidation Rate Constants, Dopant Redistribution, Oxide Charges, Device Isolation, LOCOS, Oxidation System

**Unit 3**– Lithography: Overview of Lithography, Radiation Sources, Masks, Photoresist, Components of Photoresist Optical Aligners, Resolution, Depth of Focus, Advanced Lithography: E-beam Lithography, X-ray Lithography, Ion Beam Lithography

**Unit 4**– Diffusion: Pre-Deposition and Drive-in Diffusion Modeling, Dose, 2-Step Diffusions, Successive Diffusion, Lateral Diffusion, Series Resistance, Junction Depth, Irvin's Curves, Diffusion System. Ion Implantation: Problems in Thermal Diffusion, Advantages of Ion Implantation, Applications in ICs, Ion Implantation System, Mask, Energy Loss Mechanisms, Depth Profile, Range & Straggle, Lateral Straggle, Dose, Junction Depth, Ion Implantation Damage, Post Implantation Annealing, Ion Channeling, Multi Energy Implantation

**Unit 5**– Thin Film Deposition: Physical Vapor Deposition: Thermal evaporation, Resistive Evaporation, Electron beam evaporation, Laser ablation, Sputtering Chemical Vapor Deposition: Advantages and disadvantages of Chemical Vapor deposition (CVD) techniques over PVD techniques, reaction types, Boundaries and Flow, Different kinds of CVD techniques: APCVD, LPCVD, Metalorganic CVD (MOCVD), Plasma Enhanced CVD etc.

**Unit 6**– Etching: Anisotropy, Selectivity, Wet Etching, Plasma Etching, Reactive Ion Etching.

**Unit 7** - Overview of Interconnects, Contacts, Metal gate/Poly Gate, Metallization, Problems in Aluminum Metal contacts, Al spike, Electromigration, Metal Silicides, Multi-Level Metallization, Planarization, Inter Metal Dielectric

## SUGGESTED LEARNING RESOURCES :

S.No	Title of Book	Author	Publication
1.	Silicon VLSI Technology	Plummer, Deal and Griffin	1st Edition, Pearson Education,2009
2.	. Fundamental of Semiconductor Fabrication	Sze and May	2nd Edition, Wiley India, 2009
3.	Silicon Proc Technology	ss S K Gandhi	2nd Edition, Wiley India,2009



## DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105) SEMESTER III

COURSE TITLE	:	SEMICONDUCTOR LAB FAMILIARIZATION
PAPER CODE	:	
SUBJECT CODE	:	
TREORY CREDITS	:	00
PRACTICAL CREDITS	:	02

## **Course Content:**

Demonstrations/MOOC of the following processes

- 1. RCA Cleaning
- 2. Piranha Cleaning
- 3. Dry Oxidation
- 4. Wet Oxidation
- 5. Spin Coating
- 6. Lithography
- 7. Thermal/E-beam Evaporation
- 8. Sputtering
- 9. Wet etching
- 10. Dry etching

## SUGGESTED LEARNING RESOURCES:

S.No	Title of Book		Author	Publication
1.	Silicon VLSI Technology		Plummer, Deal and Griffin	Pearson Education, !st edition, 2009
2.	Fundamental of Semiconductor Fabrication		Sze and May	Wiley India , 2 <sup>nd</sup> edition, 2009
3.	Silicon Technology	Process	S K Gandhi	Wiley India, 2 <sup>nd</sup> edition, 2009



DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA, BHOPAL DIPLOMA IN IC MANUFACTURING (105) SEMESTER - 111

COURSE TITLE	:	SUMMER INTERNSHIP - I
PAPER CODE	:	
SUBJECT CODE	:	
TREORY CREDITS	:	00
PRACTICAL CREDITS	:	02

SUMMER INTERNSHIP –

3-4 weeks summer internship after II<sup>nd</sup> Semester.

It should be undertaken in an industry/Govt. or Pvt. Certified Agencies which are in social sector/Govt. Skill Centers/Schemes.

Evaluation is based on work done, quality of report, performance in viva-voce, presentation etc.



### DIPLOMA WING RAJIV GANDHI PROUDYOGIKI VISHWAVIDYALAYA,BHOPAL DIPLOMA IN IC MANUFACTURING (105)

SEMESTER - III

COURSE TITLE	:	PROFESSIONAL DEVELOPMENT
PAPER CODE	:	
COURSE CODE	:	
TREORY CREDITS	:	00
PRACTICAL CREDITS	:	00

### **Course Objectives:**

Following are the objectives of this course:-

- (1) To learn the principles of Professional and Social ethics.
- (2) To know the concept of Lifelong learning and Self-directed learning.
- (3) To present self for employment.
- (4) To introduce the need of industrial visits.
- (5) To understand CV, Resume, Bio-data and Interview and their significance.
- (6) To develop the skills of Group Discussion.

### **Course Content:**

### **Unit - I Professional and Social Ethics**

Professional ethics, its need and importance, general code of ethics for engineers, ethical issues for engineers.

Need and importance of social skills, social skills for better group performance, important social skills such as social perceptiveness, coordination, negotiation, persuasion etc.

## Unit - II Lifelong learning and Self-directed Learning

Lifelong learning, its examples, self-directed learning, its examples, important steps in lifelong learning.

Need for planning self-directed learning, planning self-directed learning plan, examples.

### **Unit – III Career Planning**

Importance of career planning, major career opportunities in concerned branch of engineering, study of the important career opportunities regarding qualification, knowledge, skills, experience required for them, role of personal factors like personal life style, interest areas, desires, personal preferences in career planning.

Identification and detailing of important career opportunities in relation to branch of diploma, identification and detailing of important self-personal factors and self-personal preferences, development of self-career plan.

### Unit – IV Industrial Visits

Necessity of exposure to environment and practices, lectures by industry experts.

Importance of Students' industrial visits, learning through observing real life industrial systems, planning and organizing the industrial visits.

### Unit - V CV, Resume, Bio-data and Interview

Need of presenting self for employment, salient features and formats of bio-data, CV, resume, comparison of the three for their merits, limitations and specific uses, study of cases and examples of bio-data, CV, resume and covering letter by all students for self of for the given cases.

Importance of employment related interviews, purpose of interview, dress code, body language and posture of interviewee, do's and don'ts for interviews, interview checklist, practice of facing employment related interviews for all students.

### **Unit – VI Group Discussion**

Need and importance of group discussion in professional work, ideal group discussion and skills needed to effectively participate in group discussion, practice of group discussion skills.

### **Course Outcomes:**

After completing this course, the student will be able to:-

- (1) Demonstrate his/her understanding of Professional and Social ethics.
- (2) Plan self-learning and self-directed learning for completing the task.
- (3) Suggest an action plan for his career planning.
- (4) Demonstrate his/her learning from visits to industry.
- (5) Prepare CV, Resume and Bio-data along with a covering letter for a job.
- (6) Effectively face an interview.
- (7) Participate in Group discussion.

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